



November 5, 2020

(Correction of a Disclosed Item)

**Notice of the Completion of Payment of the Price for Transfer of Shares of the Subsidiary
that Manufactures Semiconductor Silicon Wafers**

With regard to the transfer of some shares (ratio of voting rights: 60%) of Hangzhou Semiconductor Wafer Co., Ltd., which is a consolidated subsidiary of the Company, to an investment fund, etc., which was announced in “Notice of the Completion of Payment of the Price for Transfer of Shares of the Subsidiary that Manufactures Semiconductor Silicon Wafers” dated October 19, 2020, we announced that the payment of the price for transfer: 1.97 billion yuan (about 29.6 billion yen) had been completed. However, it is found, through the investigation conducted by the subsidiary, that a part of the payment of the price for transfer: about 40 million yuan (about 600 million yen) was not completed. As of November 4, 2020, we have confirmed the payment.

We apologize for the correction of disclosure, and make correction in this document.